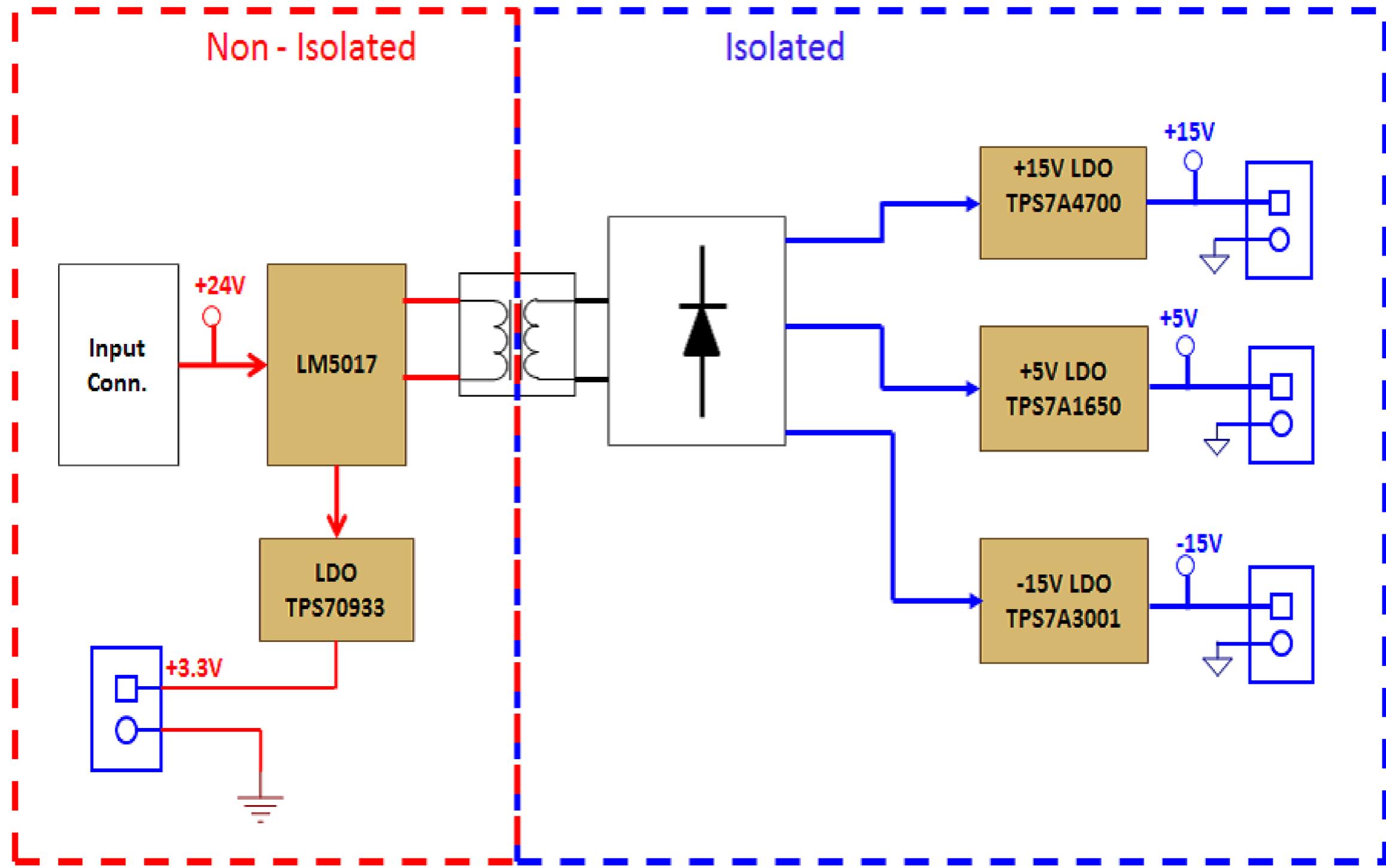


Revision History	
Revision	Notes



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H1 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H7 1902C H5 1902C H8 1902C H6 1902C

FID1 FID3 FID2 FID6 FID5 FID4

PCB Number: TIDA-00400  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant.

You can delete this note too.

LBL1  
PCB Label  
Size: 0.65" x 0.20 "

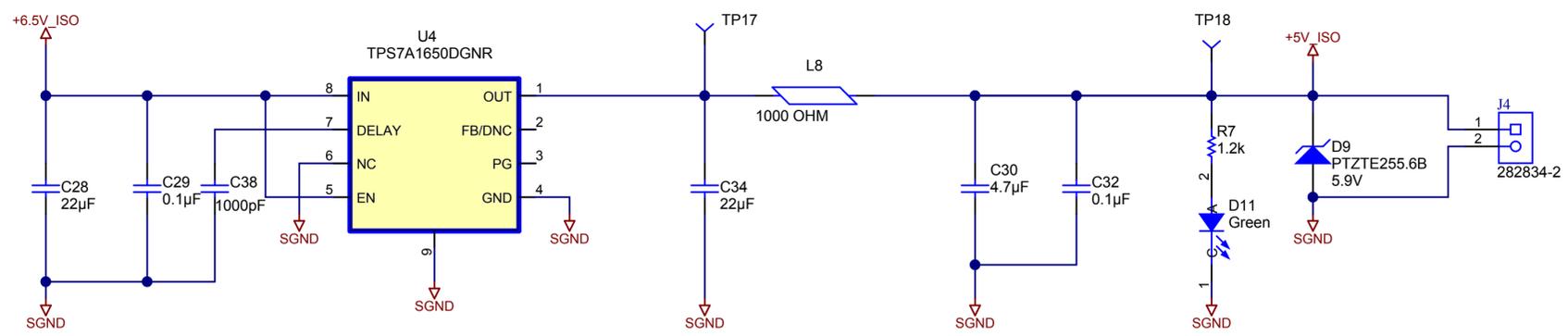
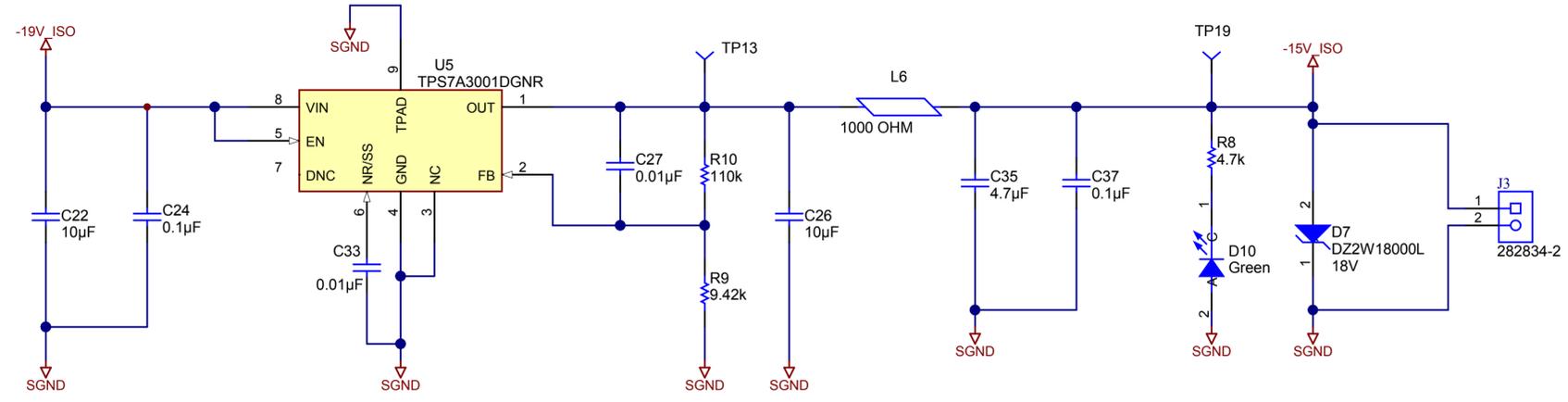
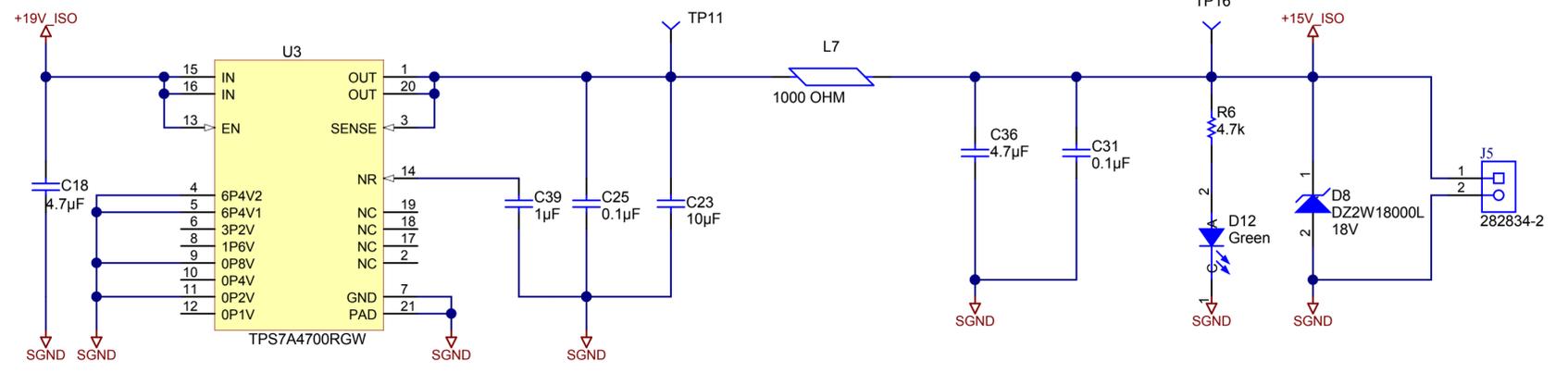
ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

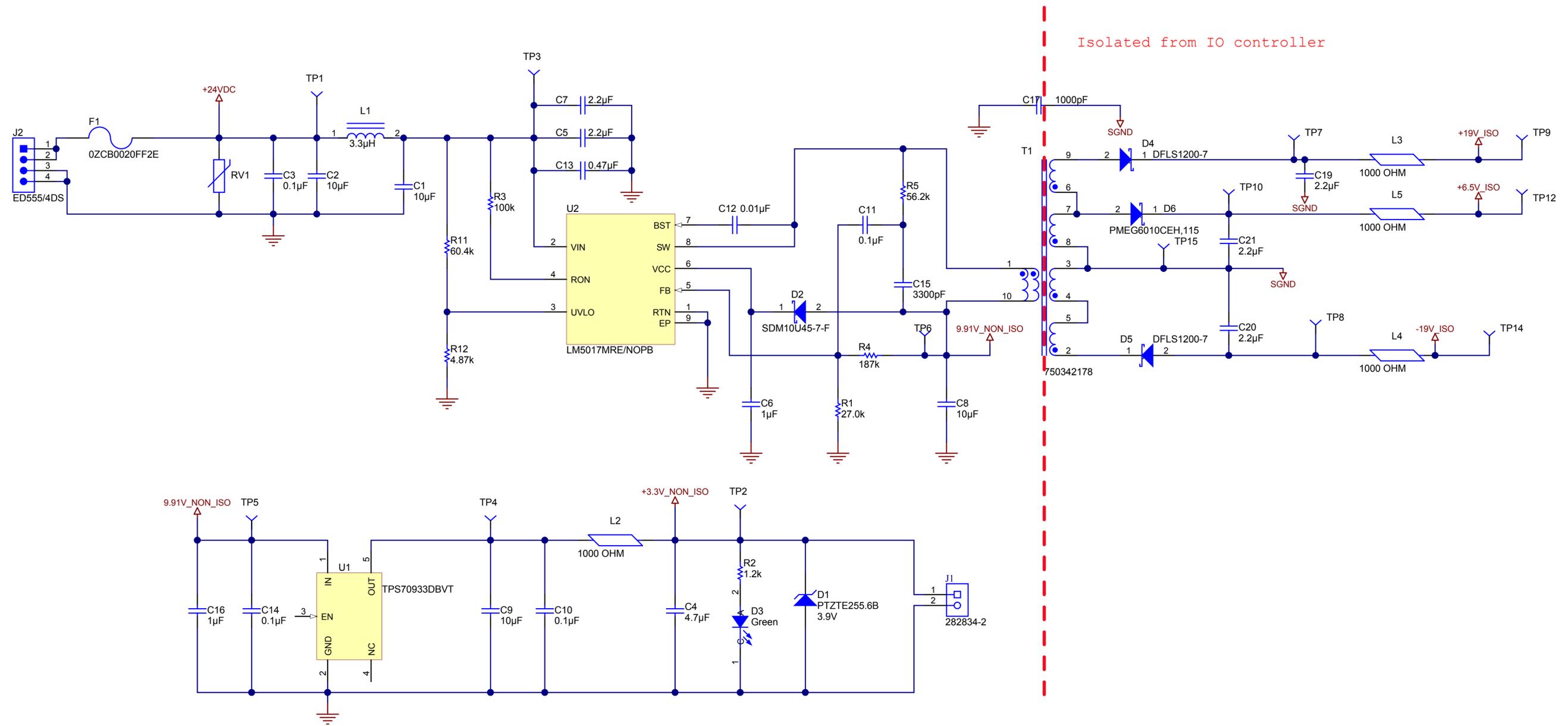
ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!



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Isolated power supply and Signal Isolation



Isolated from IO controller

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